

# Cost-optimized, battery-powered motor drive using dual-channel power MOSFET

## About this document

### Scope and purpose

This user manual describes a cost-optimized solution including the board REF\_18V\_90W\_SLFOC and its firmware from Infineon for a battery-powered motor drive application such as domestic robots or smaller power motor drives. This solution provides a complete hardware and firmware design for the PMSM motor, utilizing XMC™ 1300 Arm® Cortex®-M0 MCU, the highly integrated MOTIX™ 6ED2742S01Q gate driver, OptiMOS™ dual N-MOSFET for high efficiency, and single-shunt sensorless field-oriented control (FOC) methodology.

### Intended audience

This document is intended for users who would like to design a cost-optimized motor drive with a single-shunt sensorless FOC methodology.

**Cost-optimized, battery-powered motor drive using dual-channel power MOSFET**

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## Introduction

### 1 Introduction

Creating efficient and compact designs for battery-powered motor drives is crucial in today's competitive market. Infineon's dual-channel power MOSFETs offer a cost-optimized solution that ensures high performance and reliability, while delivering numerous customer benefits.

Infineon's solution provides the following advantages:

- **High price/performance ratio:** By integrating two MOSFETs in a single package, Infineon's dual-channel power MOSFETs deliver exceptional value, ensuring that customers get the most out of their investment
- **Lower BOM cost:** The use of sensorless field oriented control (FOC) eliminates the need for position sensors, reducing the BOM cost. This streamlined approach employs only one shunt and an integrated current sense amplifier (CSA)
- **High power efficiency:** Leveraging OptiMOS™ technology, the ISA250250N04LMDS dual N-MOSFET and the MOTIX™ 6ED2742S01Q highly integrated gate driver ensure high efficiency, contributing to longer battery life and improved performance

Infineon's cost-optimized motor drive solution, including the REF\_18V\_90W\_SLFOC board and its firmware, provides a complete package for sensorless FOC. This approach contrasts with widely used market solutions based on trapezoidal control and Hall sensors, offering a superior alternative.

Key components of this solution include:

- **XMC™ XMC1300 Arm® Cortex®-M0 MCU:** 32-bit microcontrollers with Arm® Cortex®-M0, delivering an industry-leading price/performance ratio
- **MOTIX™ 6ED2742S01Q highly integrated gate driver:** Three-phase motor control gate driver IC, ensures robust control and protection features
- **OptiMOS™ ISA250250N04LMDS dual N-MOSFET:** Dual N-channel power MOSFET 40 V in SO-8 package, optimized with OptiMOS™ technology for high efficiency

The XMC1302-Q024F0064 32-bit microcontroller with Arm® Cortex®-M0 is specifically designed for low-cost embedded control applications. The XMC1000 series is the top choice for elevating traditional 32-bit designs, covering a wide range of applications from typical 32-bit tasks to digital power conversion and even field-oriented motor control. The XMC1300 family is capable of integrating all necessary control and analog interface functions required for sensorless FOC, brushless (BLDC), brushed DC, and PMSM motors.

The MOTIX™ 6ED2742S01Q is a 160 V SOI-based gate driver specifically designed for three-phase BLDC motor drive applications. It features integrated bootstrap diodes that supply the three external high sides with charging bootstrap capacitors, supporting 100% duty cycle operation through a trickle charge pump. Protection features include undervoltage lockout, overcurrent protection with configurable thresholds, fault communication, and automatic fault clearing. The output drivers include a high-pulse current buffer stage designed to minimize driver cross-conduction. Additionally, a current sense operational amplifier (CSA) with selectable gain is integrated between VSS and COM.

This driver offers a straightforward, scalable, robust, and cost-effective one-stop solution for a variety of battery-powered applications. It is ideal for power tools, robotics, and light electric vehicles (LEVs) across a wide range of battery voltages.

Infineon offers the OptiMOS™ dual 30 V and 40 V portfolio, housed in a compact SO-8 package featuring two MOSFETs within a single package. This design supports a smaller PCB footprint, enabling more compact and efficient solutions. The new OptiMOS™ dual MOSFETs, available in both 30 V and 40 V versions, deliver a high price-performance ratio in the SO-8 package category. Infineon's dual MOSFETs, offered in N and P, as well as N

## Introduction

and N-channel configurations, are ideal for applications such as lawn mower robots, vacuum cleaner robots, drones, and various other low power DC-DC applications. A notable example from this portfolio is ISA250250N04LMDS, which features a 40 V  $V_{DS}$  and a maximum  $R_{DS(on)}$  of 25 m $\Omega$ .

This solution is ideal for motor drives in domestic robots and smaller power motor drives, addressing a wide range of battery-powered applications with a focus on cost-effectiveness and performance.

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## System overview

## 2 System overview

### 2.1 System block diagram

Figure 1 shows a simplified system block diagram where OptiMOS™ 6 ISA250250N04LMDS dual N channel power MOSFET is used for a three-phase PMSM motor control system.

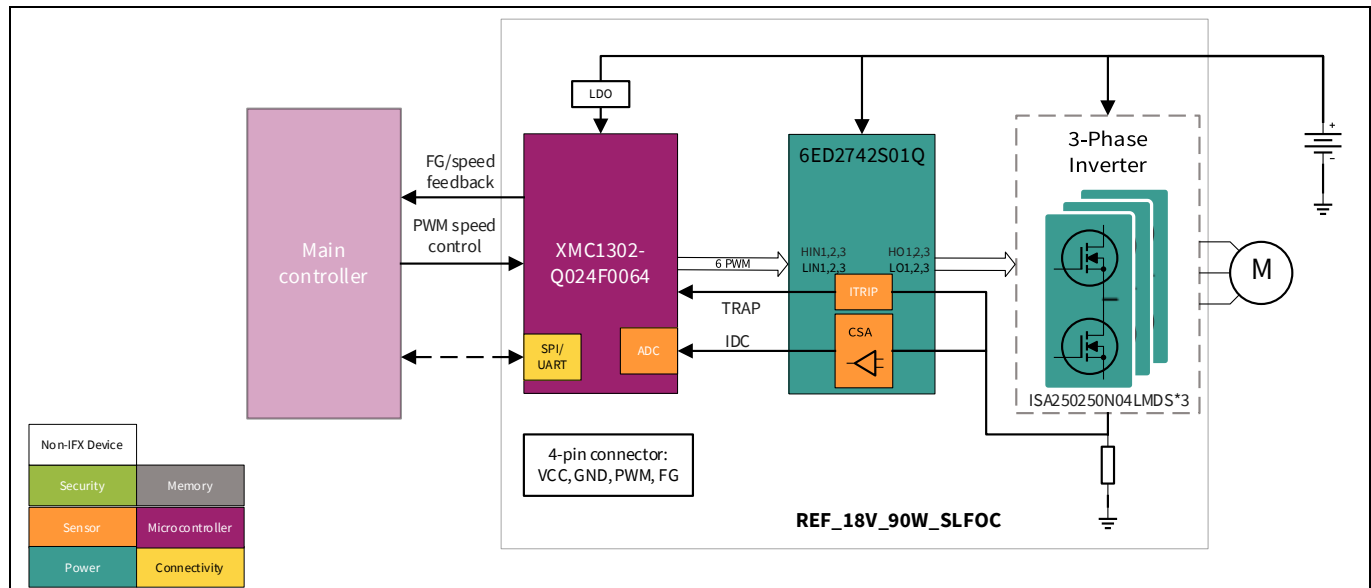


Figure 1 System block diagram

### 2.2 Board overview

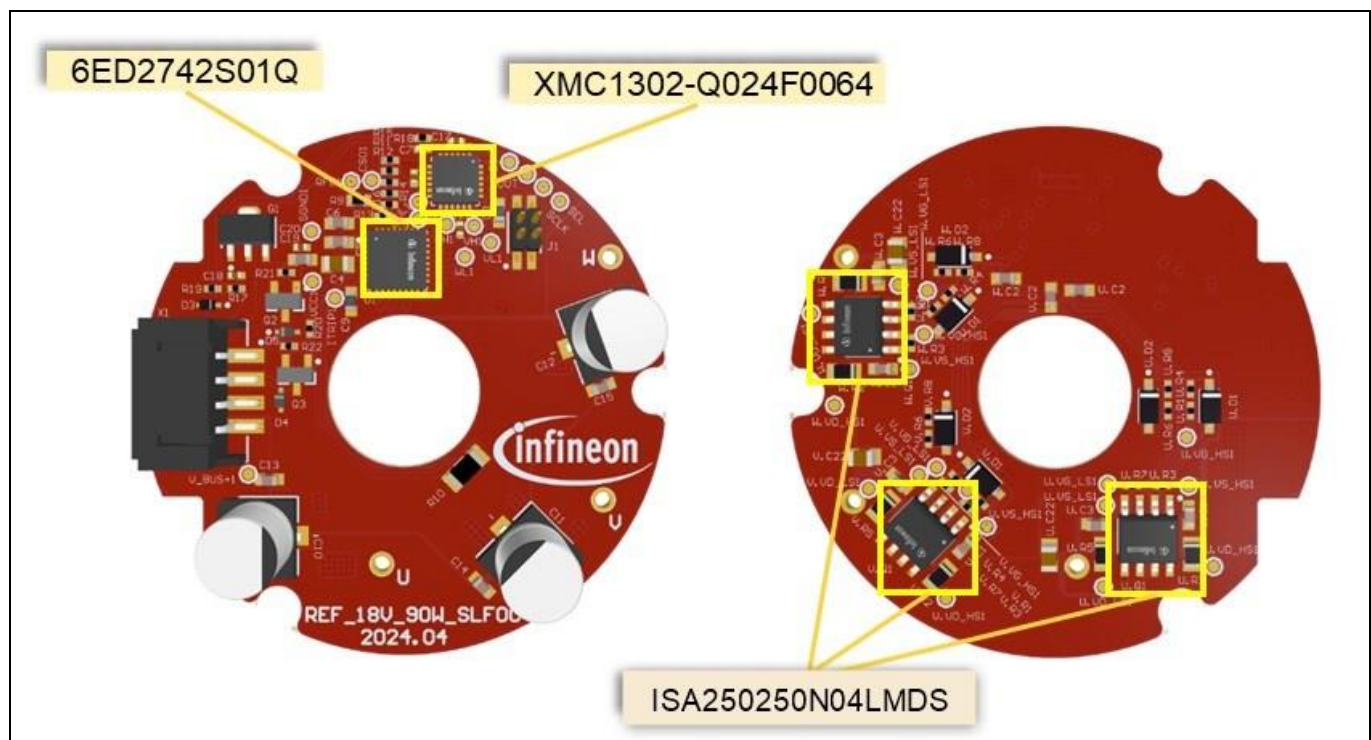


Figure 2 Reference board REF\_18V\_90W\_SLFOC

## System overview

### 2.3 Board connections

**Table 1 Board connections**

Connector	Pin	Symbol	Function
X1	1	FG	Speed feedback
	2	PWM	Speed input
	3	GND	Ground
	4	PVDD	Power supply input
J1 (Debugger)	1	DVDD	+3.3 V supply
	2	SWDIO	SWD data
	3	GND	GND
	4	SWDCLK	SWD clock
Inverter output	U	U	Motor terminal connection - U
	V	V	Motor terminal connection - V
	W	W	Motor terminal connection - W

### 2.4 Specifications

**Table 2 Board specifications**

Parameters	Symbol	Values			Unit	Notes
		Min.	Nom.	Max.		
Supply voltage	$V_{in}$	10	18	21	V	–
Max output current	$I_{out\_max}$	–	5	–	A	Ambient temperature: 25°C, 10 minutes, continuous, RMS
Max output power	$P_{out\_max}$	–	90	–	W	Ambient temperature: 25°C, 10 minutes, continuous
Peak output current	$I_{out\_peak}$	–	10	–	A	Ambient temperature: 25°C, 30 seconds, RMS
Peak output power	$P_{out\_peak}$	–	180	–	W	Ambient temperature: 25°C, 30 seconds
Number of shunts	–	–	1	–	–	Current sensing shunt
Switching frequency	$F_{PWM}$	–	20	–	kHz	–
Board outer diameter	$D_{outer}$	–	45	–	mm	Circular board outer diameter
Board Inner hold diameter	$D_{inner}$	–	13	–	mm	Circular board inner hold diameter



## Cost-optimized, battery-powered motor drive using dual-channel power MOSFET

## Schematics and PCB layout

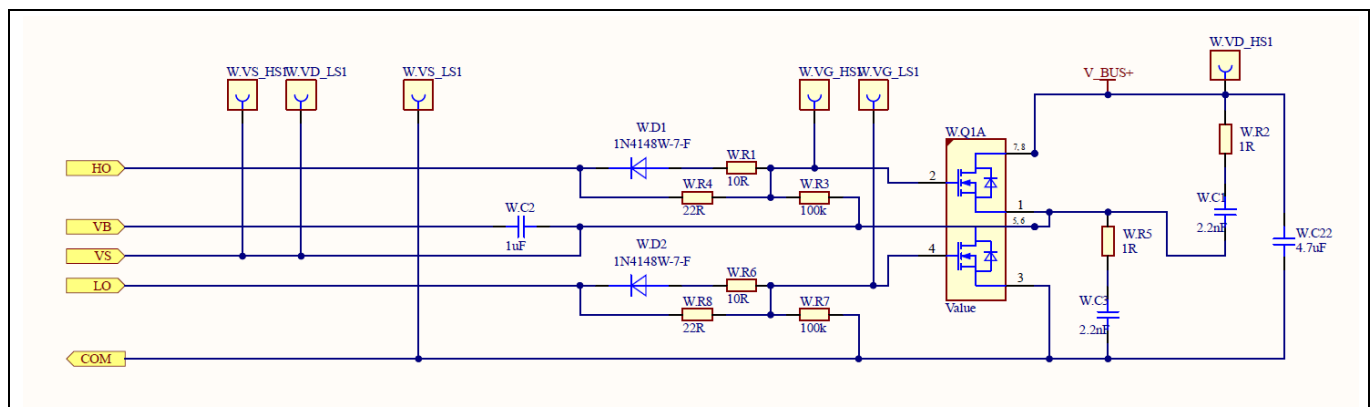


Figure 6 Power stage - phase “W”

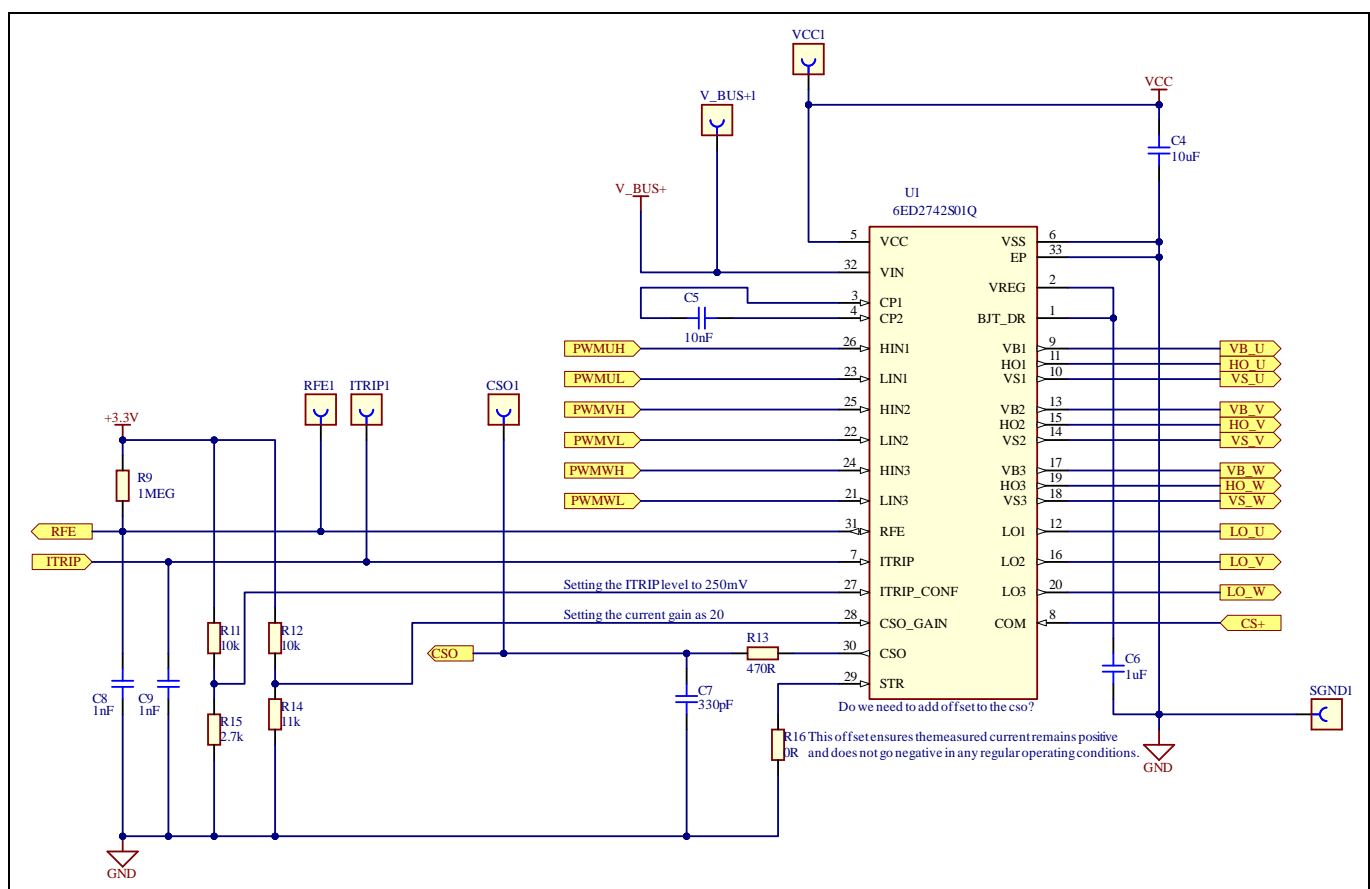
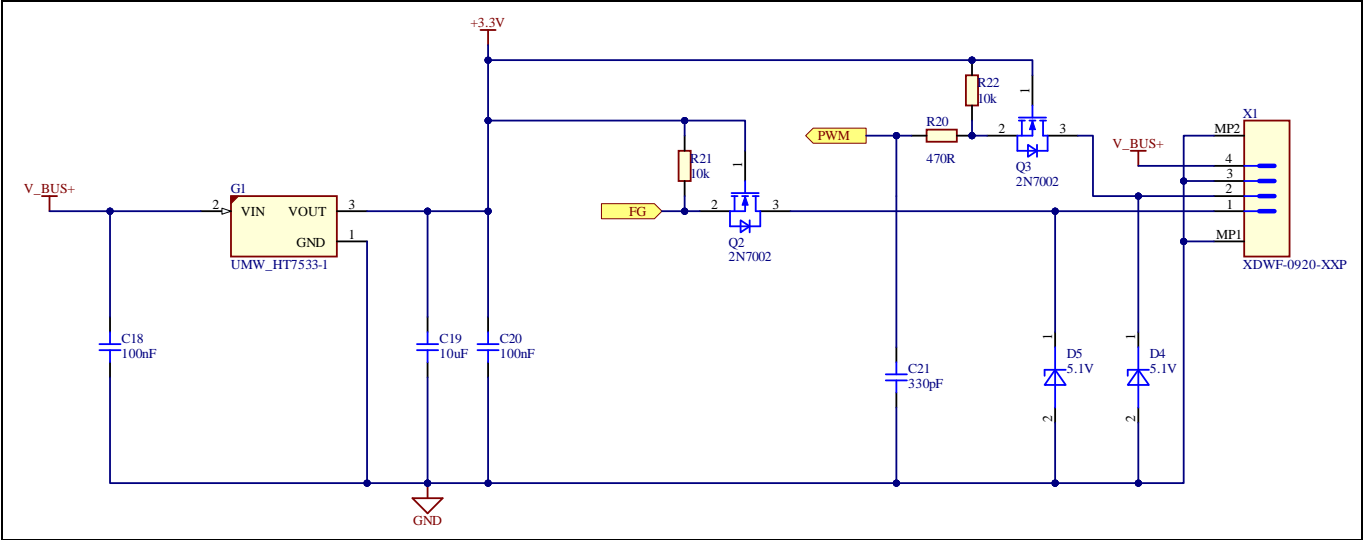


Figure 7 Gate driver 6ED2742S01Q



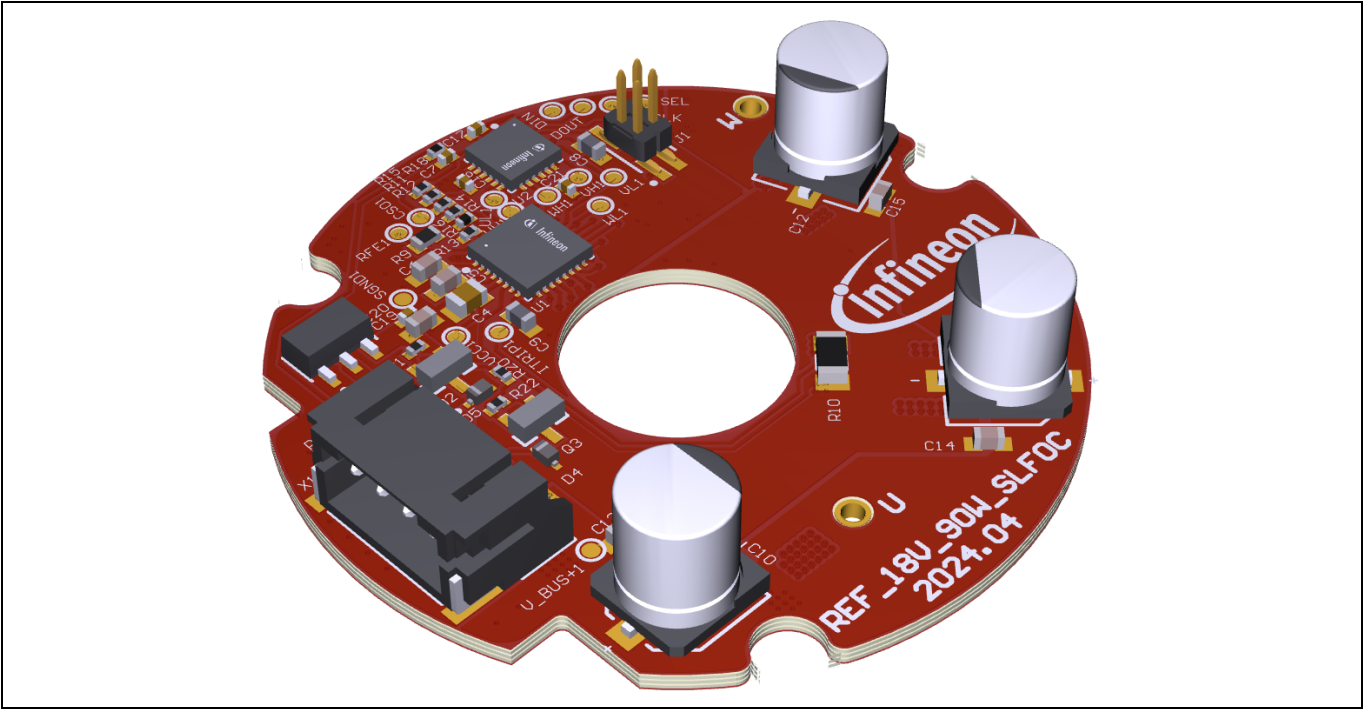
# Cost-optimized, battery-powered motor drive using dual-channel power MOSFET

## Schematics and PCB layout



**Figure 8** Auxiliary power supply and connector

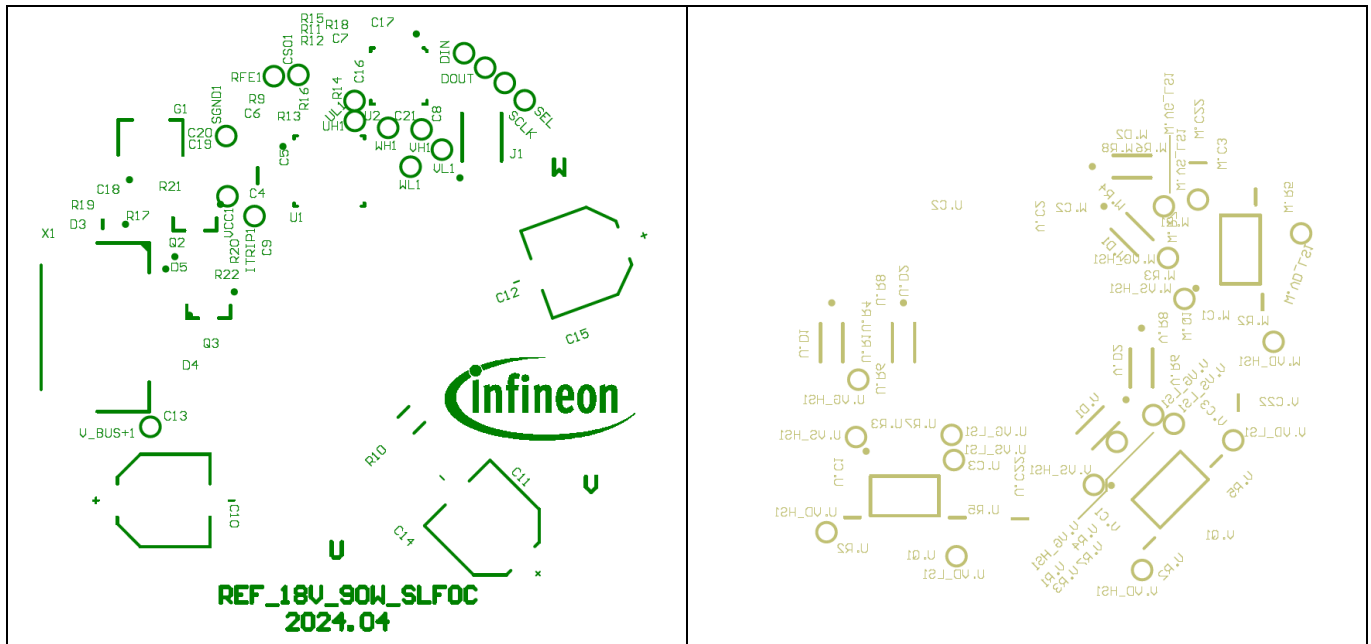
### 3.2 PCB layout



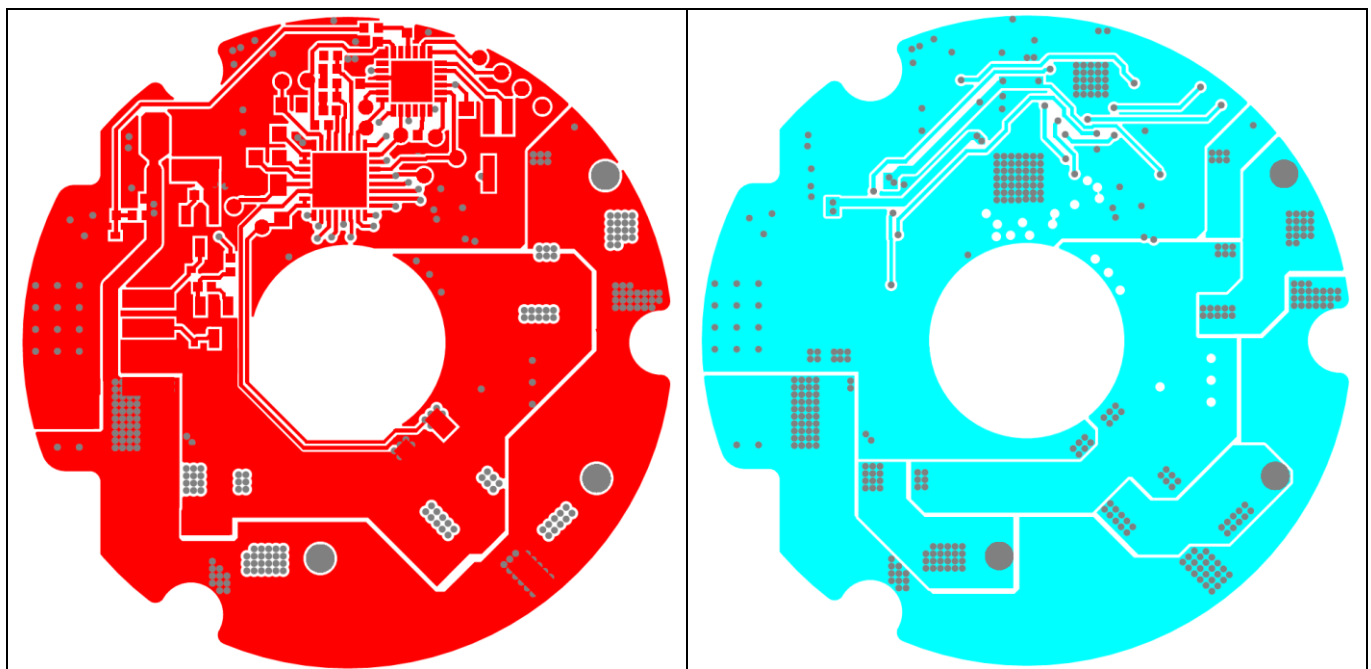
**Figure 9** Board 3D view

# Cost-optimized, battery-powered motor drive using dual-channel power MOSFET

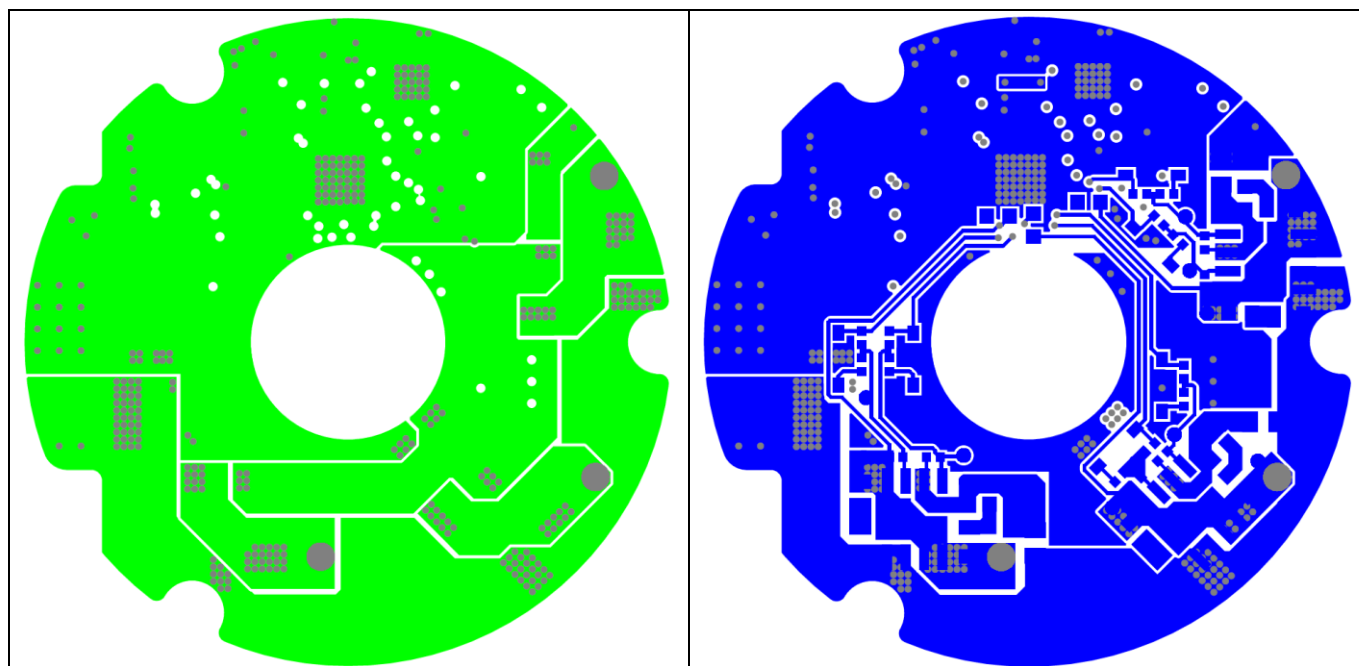
## Schematics and PCB layout



**Figure 10** Top overlay and bottom overlay



**Figure 11** Top layer and MID1 layer



**Figure 12** MID2 layer and Bottom layer

### 3.3 Bill of materials (BOM)

**Table 3** BOM

Reference	Qty	Value/rating	Manufacturer	Part number
C4	1	10uF / 25V / 0805	Murata	GRM219R61E106MA12
C5	1	10nF / 25V / 0603	Murata	GRM188R71E103JA01
C6, U.C2, V.C2, W.C2	4	1uF / 50V, 25V / 0603	Murata	GRM188R61H105KAAL, GRM188R71E105KA12
C7, C21	2	330pF / 25V / 0402	Murata	GRM1555C1E331JA01
C8, C9	2	1nF / 50V / 0603	Kemet	C0603C102F5GAC
C10, C11, C12	3	47uF / 35V /	Nippon Chemi-Con	EMVE350ARA470MF80G
C13, C14, C15	3	2.2uF / 50V / 0603	Murata	GRM188R61H225KE11
C16, C18, C20	3	100nF / 16V, 50V / 0402	Murata	GRM155R61C104JA88, GRM155R61H104KE14D
C17	1	10nF / 25V / 0402	Murata	GRM155R71E103KA01
C19	1	10uF / 16V / 0603	Murata	GRM188R61C106KAAL
D3	1	3.3V	ON Semiconductor	SZMM5Z3V3T1G
D4, D5	2	5.1V	ON Semiconductor	MM5Z5V1T1G
G1	1	UMW_HT7533-1	-	UMW_HT7533-1
J1	1	62130421021	Wurth Elektronik	62130421021
Q2, Q3	2	2N7002	ON Semiconductor	2N7002

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## Schematics and PCB layout

Reference	Qty	Value/rating	Manufacturer	Part number
R9	1	1MEG / 75V	Vishay	CRCW06031M00FK
R10	1	10mR / 1206	Vishay	WSLP1206R0100FEA
R11, R12, R21, R22	4	10k / 50V / 0402	Vishay, Panasonic	CRCW040210K0FK, ERJ2GEJ103X
R13, R20	2	470R / 50V / 0402	Vishay	CRCW0402470RFK
R14	1	11k / 50V / 0402	Vishay	CRCW040211K0FK
R15	1	2.7k / 50V / 0402	Vishay	CRCW04022K70FK
R16	1	0R / 50V / 0402	Yageo	RC0402JR-070RL
R17	1	75k / 50V / 0402	Vishay	CRCW040275K0FK
R18	1	0R / 50V / 0402	ROHM Semiconductors	SFR01MZPJ000
R19	1	7.87k / 50V / 0402	Vishay	CRCW04027K87FK
U1	1	6ED2742S01M	Infineon Technologies	6ED2742S01M
U2	1	IFX_XMC1302-Q024F0064	Infineon Technologies	XMC1302-Q024F0064
U.C1, U.C3, V.C1, V.C3, W.C1, W.C3	6	2.2nF / 50V / 0603	Murata	GRM188R71H222JA01
U.C22, V.C22, W.C22	3	4.7uF / 50V / 0805	Murata	GRM21BR61H475KE51
U.D1, U.D2, V.D1, V.D2, W.D1, W.D2	6	1N4148W-7-F	Diodes Incorporated	1N4148W-7-F
U.Q1, V.Q1, W.Q1	3		Infineon Technologies	ISA025025N04LMDS
U.R1, U.R6, V.R1, V.R6, W.R1, W.R6	6	10R / 50V / 0402	Vishay	CRCW040210R0FK
U.R2, U.R5, V.R2, V.R5, W.R2, W.R5	6	1R / 150V / 0805	Vishay	CRCW08051R00FK
U.R3, U.R7, V.R3, V.R7, W.R3, W.R7	6	100k / 50V / 0402	Vishay	CRCW0402100KFK
U.R4, U.R8, V.R4, V.R8, W.R4, W.R8	6	22R / 50V / 0402	Vishay	CRCW040222R0FK
X1	1	XDWF-0920-XXP	-	XDWF-0920-XXP

# Cost-optimized, battery-powered motor drive using dual-channel power MOSFET



## Revision history

### Revision history

Document revision	Date	Description of changes
V 1.0	2025-02-06	Initial release

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